



# TAI-SAW TECHNOLOGY CO., LTD.

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## Product Specifications Approval Sheet

Product Description: Crystal Unit SMD 3.2x2.5 26MHz

TST Part No.: TZ1689A

Customer Part No.: \_\_\_\_\_

Customer signature required
Company: _____
Division: _____
Approved by : _____
Date: _____

Checked by: \_\_\_\_\_ Yifan Chen *Yifan*

Approved by: \_\_\_\_\_ Kelly Huang *Kelly Huang*

Date: \_\_\_\_\_ 10/21/2019

1. Customer signed back is required before TST can proceed with sample build and receive orders.
2. Orders received without customer signed back will be regarded as agreement on the specifications.
3. Any specifications changes must be approved upon by both parties and a new revision of specifications shall be released to reflect the changes.



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Crystal Unit SMD 3.2x2.5 26MHz

MODEL NO.: TZ1689A

REV. NO.: 7.0

## Revise:

Rev.	Rev. Page	Rev. Account	Date	Ref. No.	Reviser
1	N/A	Initial release	10/30/09'	N/A	Ann Liu
2	4	Pin connection updated	07/28/10'	ECN-20100267	Ann Liu
3	4	Change Mechanical Dimensions	03/12/12'	ECN-201200106	Ginger Huang
4	3	Add DLD spec	09/04/12'	ECN-201200258	Ginger Huang
5	7	Add free drop test in RA table	04/03/18'	ECN-201800150	Chia Haur Rau
6	4	Renew marking rule	06/27/19'	ECN-201900296	Chia Haur Rau
7	4	Add Base2	10/21/19'	ECN-201900483	Yifan Chen



MODEL NO.: TZ1689A

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## Features:

- Surface Mount Hermetic Package
- Excellent Reliability Performance
- Good Frequency Perturbation and Stability over temperature
- Ultra Miniature Package
- Moisture Sensitivity Level (MSL) : Level-1

RoHS Compliant  
 Lead free  
 Lead-free soldering

## Description and Applications:

Surface mount 3.2mmx2.5mm crystal unit for use in wireless communications devices, especially for a need of ultra miniature package for mobility.

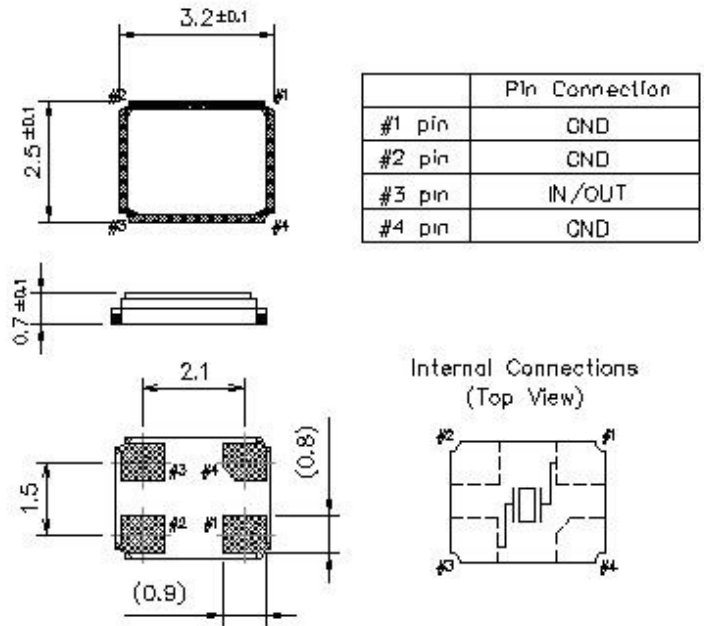
## Electrical Specifications:

<b>TZ1689A</b>	<b>Specification</b>
Nominal Frequency	26.000000 MHz
Mode of Oscillation	Fundamental
Storage Temperature Range	-40°C to +85°C
Frequency Perturbation	+/-1.0 ppm
Operating Temperature Range	-20°C to +75°C
Frequency Stability over Operating Temperature Range	+/-10 ppm (referred to the value at 25°C)
Frequency Make Tolerance (FL)	+/-10 ppm @ 25°C +/- 3°C
Equivalent Series Resistance (ESR)	30Ω max.
Drive Level Dependence Delta R Delta F	8 drive levels (0.00003, 0.0003, 0.003, 0.03, 0.3, 3, 50, 100uW) < 1.8 Ω max < 2 ppm max
Nominal Drive Level	100 uW (typ.) ; 200uW (max.)
Motional Capacitance (C1)	4.4 fF +/- 15%
Shunt Capacitance (Co)	3.0 pF max
Pulling Sensitivity	32ppm/pF +/- 10% (@7.3pF Load)
Load Capacitance (CL)	7.3 pF

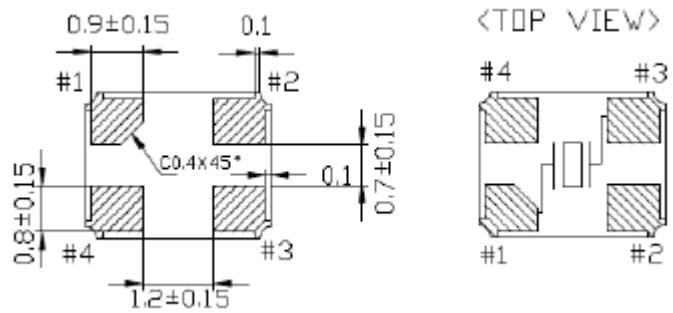
Insulation Resistance	500 MΩ min./DC 100V
Marking	Laser Marking
Unit Weight	0.017+/-0.005 g

### Mechanical Dimensions (mm):

#### Base1

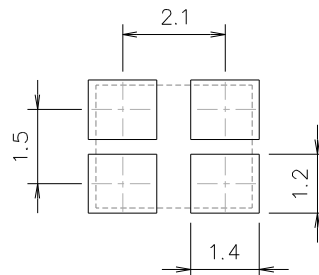


#### Base2



### Recommended Land Pattern: (unit: mm)

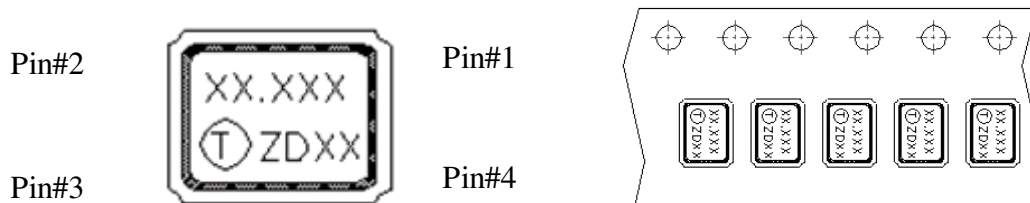
Reference Footprint



## Marking:

Line 1: Frequency (26.000)

Line 2: TST Logo + Crystal Product Code + Date Code + Traceability code ( 1 or 2 letters, underline or no underline)



The inner vision of Pin#1, Pin#4 side is XTAL blank mounting pad.

### Product Code Table

Year	2013	2014	2015	2016
	2017	2018	2019	2020
	2021	2022	2023	2024
product code	Z	z	<u>Z</u>	<u>z</u>

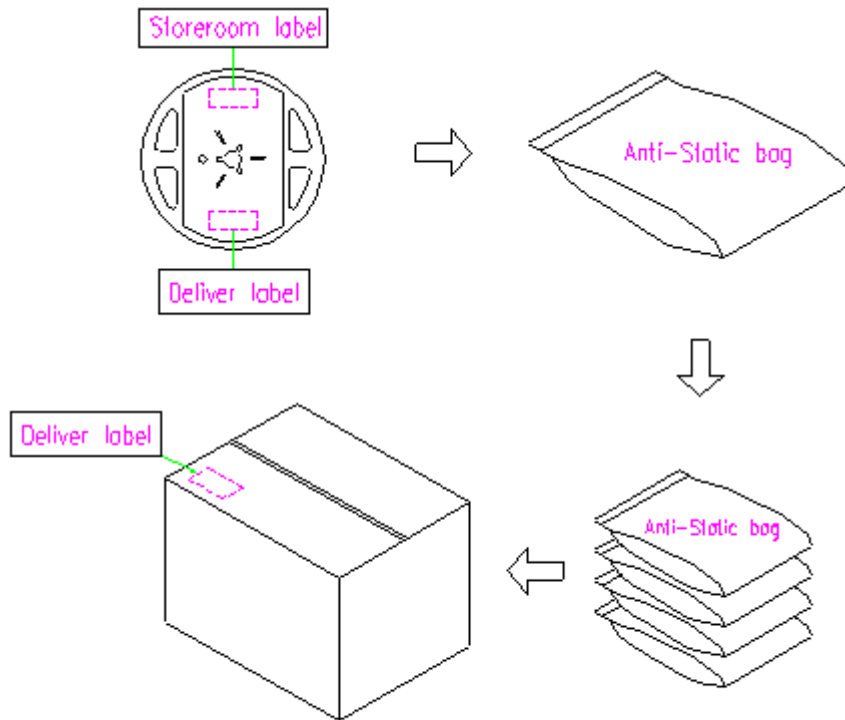
### Date Code Table

WK01	WK02	WK03	WK04	WK05	WK06	WK07	WK08	WK09	WK10	WK11	WK12	WK13
A	B	C	D	E	F	G	H	I	J	K	L	M
WK14	WK15	WK16	WK17	WK18	WK19	WK20	WK21	WK22	WK23	WK24	WK25	WK26
N	O	P	Q	R	S	T	U	V	W	X	Y	Z
WK27	WK28	WK29	WK30	WK31	WK32	WK33	WK34	WK35	WK36	WK37	WK38	WK39
a	b	c	d	e	f	g	h	i	j	k	l	m
WK40	WK41	WK42	WK43	WK44	WK45	WK46	WK47	WK48	WK49	WK50	WK51	WK52
n	o	p	q	r	s	t	u	v	w	x	y	z

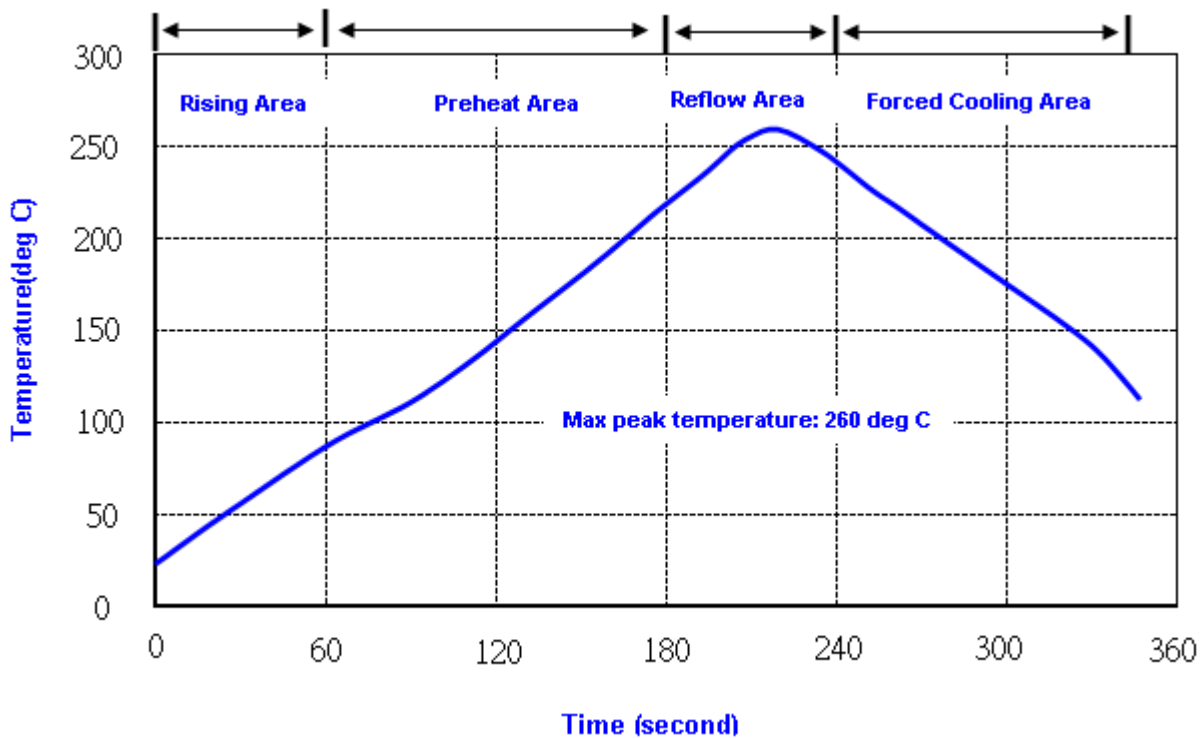


## Packing Quantity/Packing:

3K pcs maximum per reel



## Reflow Profile:



- Note: 1. Max peak temperature: 260 $\pm$ 5 deg C; Time: 10 $\pm$ 2 sec  
 2. Temperature: 217 $\pm$ 5 deg C; Time: 90~100 sec

## Reliability Specifications

Test name	Test process / method	Reference standard
<b>Mechanical characteristics</b>		
resistance to Soldering heat (IR reflow)	Temp./ Duration : 265°C /10sec ×2 times Total time : 4min.(IR-reflow)	EIAJED-4701 -300(301)M(II)
Vibration	Total peak amplitude : 1.5mm Vibration frequency : 10 to 2000 Hz Sweep period : 20 minute Vibration directions : 3 mutually perpendicular Duration : 2 hr / direc.	MIL-STD 202G method 204
Drop test	150 cm with load on Concrete floor 6 mutually perpendicular x 1time	
Mechanical Shock	directions : 3 impacts per axis Acceleration : 3000g's, +20/-0 % Duration : 0.3 ms (total 18 shocks) Waveform : Half-sine	MIL-STD 202G method 213
Solderability	Solder Temperature:265±5°C Duration time: 5±0.5 seconds.	J-STD-002
<b>Environmental characteristics</b>		
Thermal Shock	Heat cycle conditions -40 °C (30min) ↔ 85 °C (30min) * cycle time : 10 times	MIL-STD 883G method 1010.8
Humidity test	Temperature : 85 ± 2 °C Relative humidity : 85% Duration : 96 hours	MIL-STD 202G method 103
Dry heat ( Aging test )	Temperature : 125 ± 2 °C Duration : 168 hours	MIL-STD 202G method 108A
Cold resistance (Low Temp Storage)	Temperature : -40 ± 2 °C Duration : 96 hours	IEC 60068-2-1